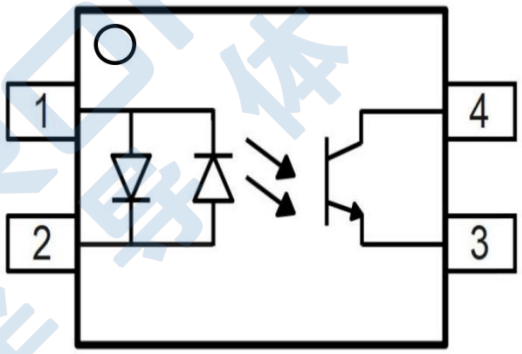
Features

- High isolation 3750 VRMS
- CTR flexibility available see order information
- AC input with transistor output
- Operating temperature range - 40 °C to 110 °C
- REACH、ROHS compliance
- Halogen free
- MSL class 1
- Regulatory Approvals
  - UL - UL1577
  - VDE - EN60747-5-5(VDE0884-5)
  - CQC – GB4943.1

Description

The IS354x series combine two AlGaAs infrared emitting diode as the AC input which is optically coupled to a silicon planar phototransistor detector in a plastic SOP4 package.

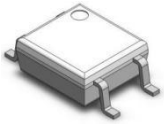
With the robust coplanar double mold structure, IS354x series provide the most stable isolation feature.



Applications

. AC line monitor
. Programmable controller
. Telephone line interface
. System appliance
. Measurement instrument

ORDERING INFORMATION

Outline	Part Number	Package	Marking	Packing	Packing Size	Quantity
	IS354A	SOP4	IS354X /YYWW A	Reel	13 ″	3000
	IS354B					

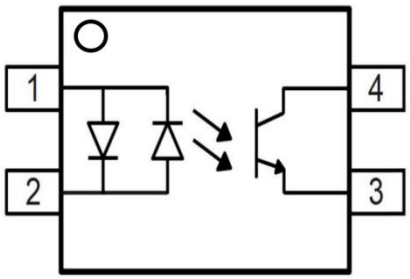
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CONTENTS

Pin Configuration An Functionsd 3
A solute Maximum Ratingsb 3
Electrical Optical Characteristics 4
Characteristic Curves 5
Test Circuits 7
Package Dimensions 8
Recommen e Sol er Maskddd 8
Carrier Tape Specifications 9
Or ering An Marking Informationdd 10
Reflow Information 11
Temperature Profile Of Sol eringd 12
Disclaimer 13

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PIN CONFIGURATION AND FUNCTIONS



Pin	Name
1	Anode/Cathode
2	Cathode/Anode
3	Emitter
4	Collector

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit	Note
INPUT				
Forward Current	I_F	±60	mA	
Peak Forward Current	I_{FP}	±1	A	1
Input Power Dissipation	P_I	100	mW	
OUTPUT				
Collector - Emitter Voltage	V_{CEO}	80	V	
Emitter - Collector Voltage	V_{ECO}	7	V	
Collector Current	I_C	50	mA	
Output Power Dissipation	P_O	150	mW	
COMMON				
Total Power Dissipation	P_{tot}	200	mW	
Isolation Voltage	V_{iso}	3750	Vrms	2
Operating Temperature	T_{opr}	-40~110	°C	
Storage Temperature	T_{stg}	-55~150	°C	
Soldering Temperature	T_{sol}	260	°C	

Note 1. 100μs pulse, 100Hz frequency

Note 2. AC For 1 Minute, R.H. = 40 ~ 60%

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ELECTRICAL OPTICAL CHARACTERISTICS(T_a=25°C)

Parameter		Symbol	Min	Typ.	Max.	Unit	Test Condition	Note
INPUT								
Forward Voltage		V_F	-	1.24	1.4	V	I_F= ±10mA	
Input Capacitance		C_{in}	-	10	-	pF	V=0, f=1kHz	
OUTPUT								
Collector Dark Current		I_{CEO}	-	-	100	nA	V_{CE}=20V, I_F=0	
Collector-Emitter Breakdown Voltage		BV_{CEO}	80	-	-	V	I_C=0.1mA, I_F=0	
Emitter-Collector Breakdown Voltage		BV_{ECO}	7	-	-	V	I_E=0.1mA, I_F=0	
TRANSFER CHARACTERISTICS								
Current Transfer Ratio	IS354A	CTR	50	-	150	%	I_F= ±1mA, V_{CE}=5V	
	IS354B		80	-	400			
CTR Symmetry			0.7	-	1.3		I_F= ±1mA, V_{CE}=5V	
Collector-Emitter Saturation Voltage		$V_{CE(sat)}$	-	0.07	0.2	V	I_F= ±20mA, I_C=1mA	
Isolation Resistance		R_{ISO}	10^12	10^14	-	Ω	DC500V, 40 ~ 60% R.H.	
Floating Capacitance		C_{IO}	-	0.4	1	pF	V=0, f=1MHz	
Response Time (Rise)		t_r	-	5	18	μs	V_{CE}=2V, I_C=2mA	3
Response Time (Fall)		t_f	-	6	18	μs	R_L= 100Ω	3

Note 3. Fig.12&13

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CHARACTERISTIC CURVES

Fig.1 Forward Current vs. Ambient Temperature

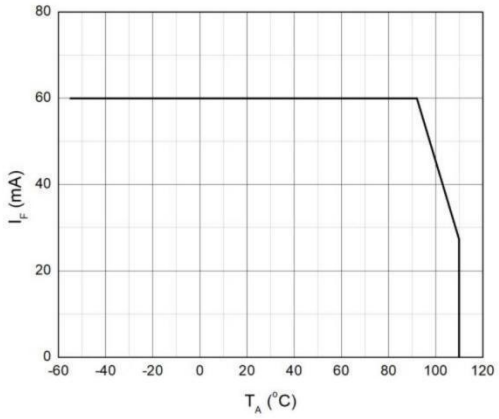


Fig.2 Collector Power Dissipation vs. Ambient Temperature

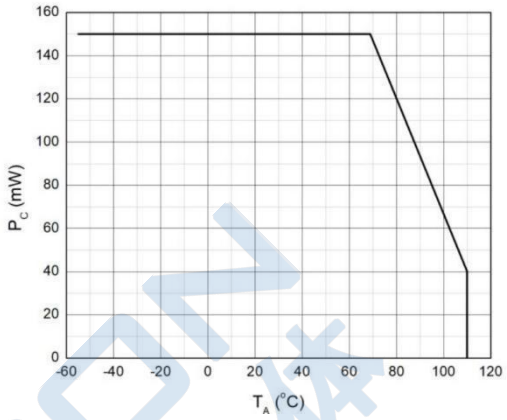


Fig.3 Forward Current vs. Forward Voltage

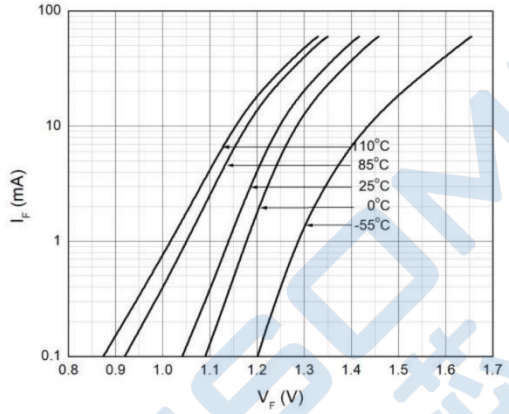


Fig.4 Collector Dark Current vs. Ambient Temperature

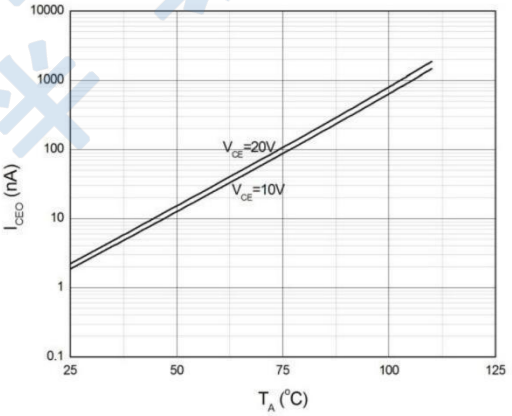


Fig.5 Collector Current vs. Collector-emitter Voltage

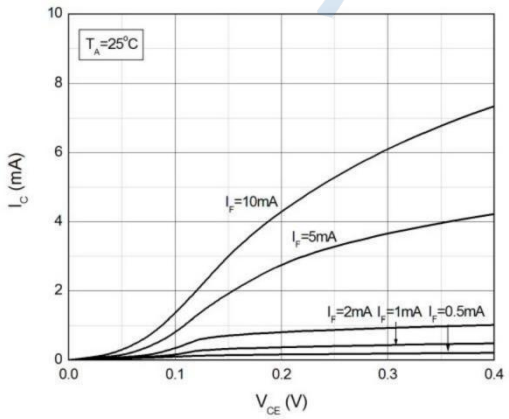
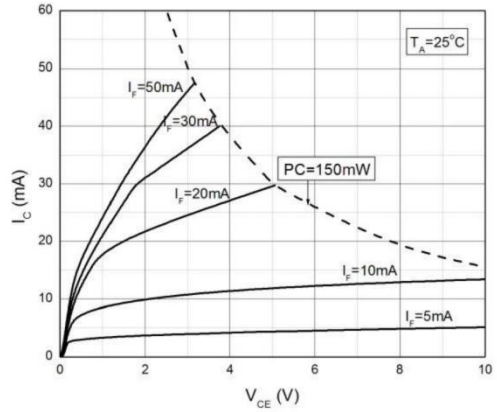


Fig.6 Collector Current vs. Collector-emitter Voltage



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Fig.7 Normalized Current Transfer Ratio vs. Forward Current

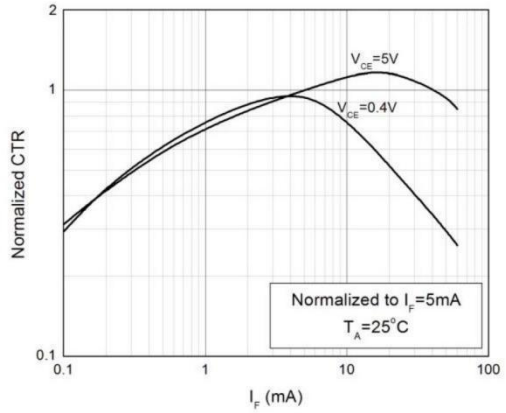


Fig.8 Normalized Current Transfer Ratio vs. Ambient Temperature

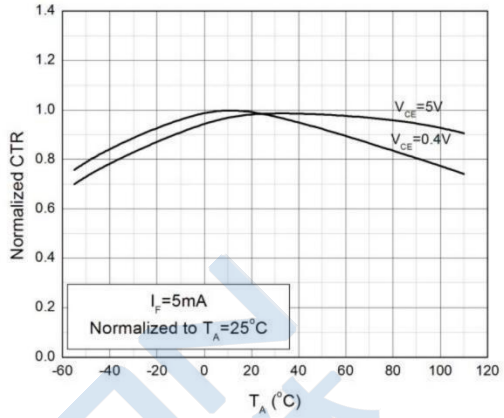


Fig.9 Collector-emitter Saturation Voltage vs. Ambient Temperature

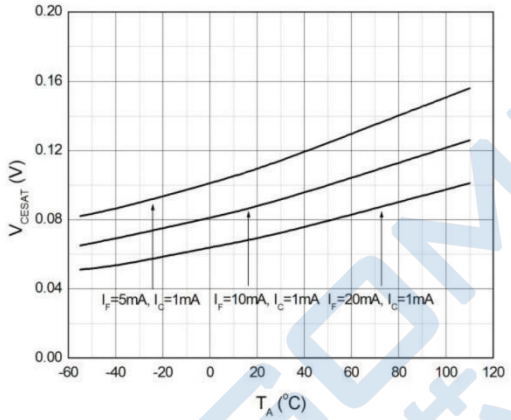


Fig.10 Switching Time vs. Load Resistance

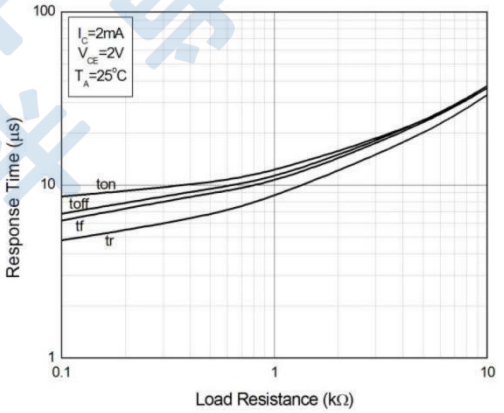
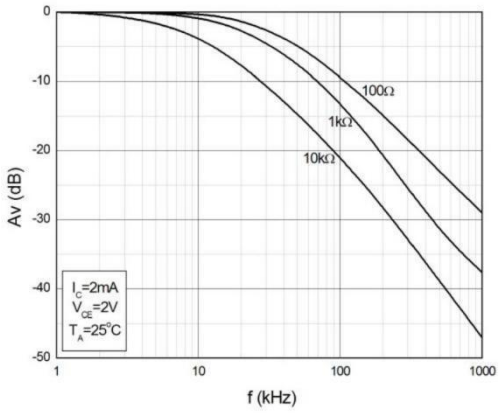
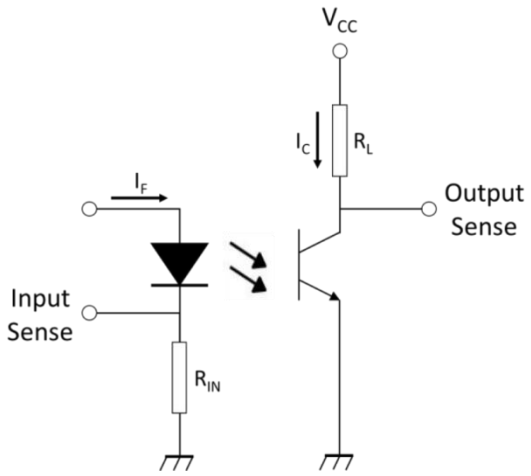
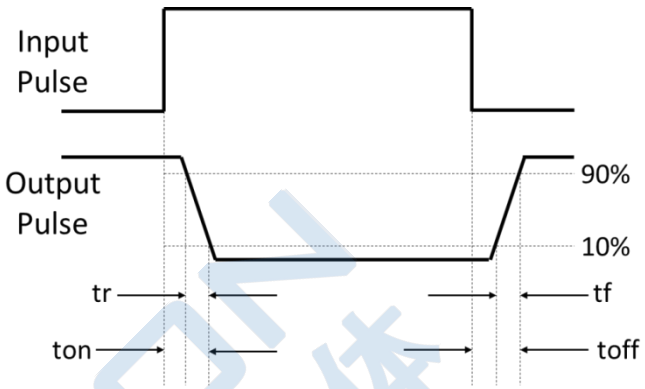


Fig.11 Frequency Response



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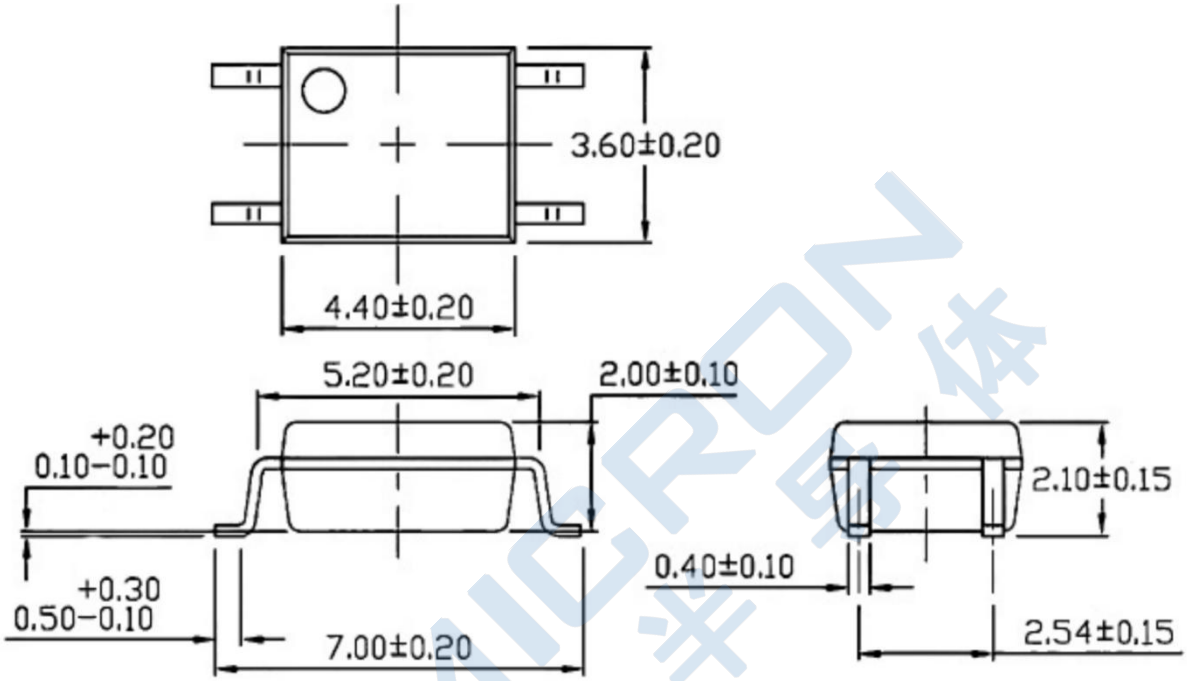
TEST CIRCUITS

Fig.12 Test Circuits of Response Time	Fig.13 Curves of Response Time
	

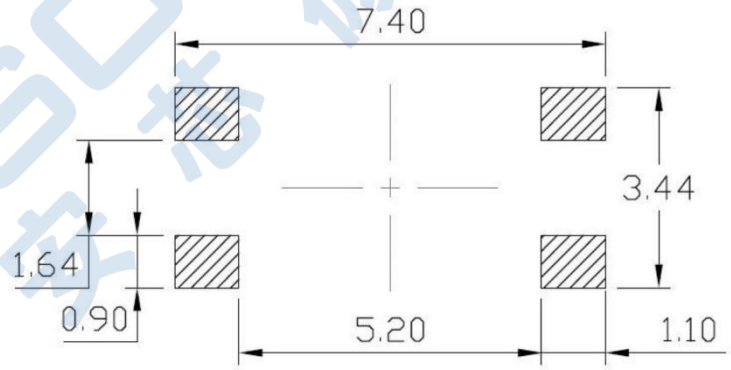
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PACKAGE DIMENSIONS

Surface Mount (Low Profile) - (SOP4)



Recommended Solder Mask

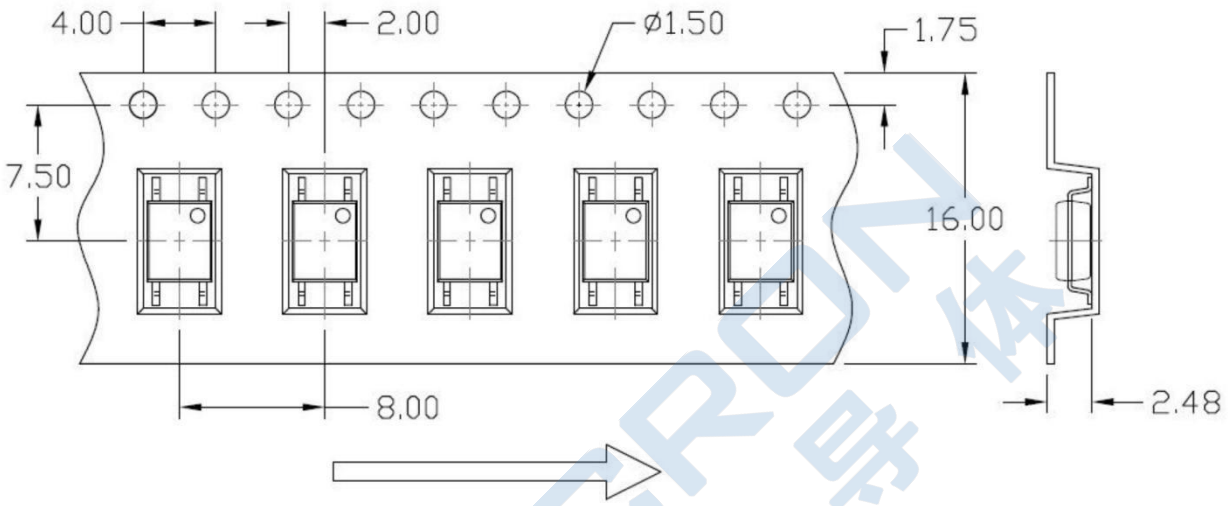


- **Dimensions in mm unless otherwise stated**

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CARRIER TAPE SPECIFICATIONS

Option SOP4



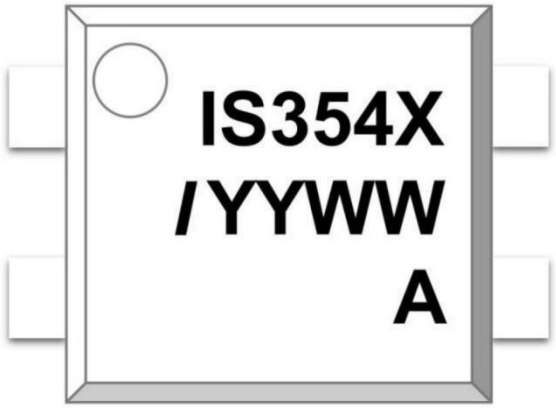
- **Dimensions in mm unless otherwise stated**

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ORDERING AND MARKING INFORMATION

Marking Information



IS	:	Company Abbr.
354	:	Part Number
X	:	CTR Rank（A/B）
/	:	ISOMICRON
YY	:	Fiscal Year
WW	:	Work Week
A	:	Manufacturing Code

Order Code

IS 354 X- X X

Company Abbr.

Part Number

CTR Rank:
A/B

Halogen Free:
E/None: Halogen-free, Lead-free
Z: Halogen, Lead-free

Performance:
N: Enhanced
None: Normal

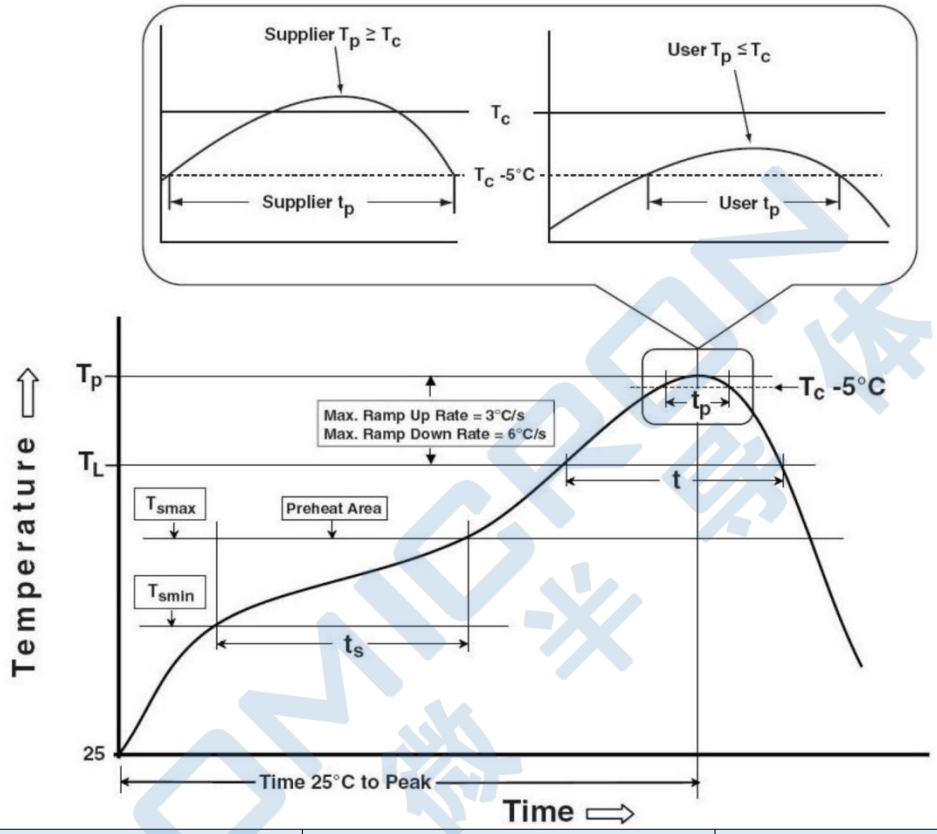
Packing Quantity

Option	Quantity	Quantity – Inner box	Quantity – Outer box
SOP4	3000 Units/Reel	2 Reels/Inner box	5 Inner box/Outer box = 30k Units

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REFLOW INFORMATION

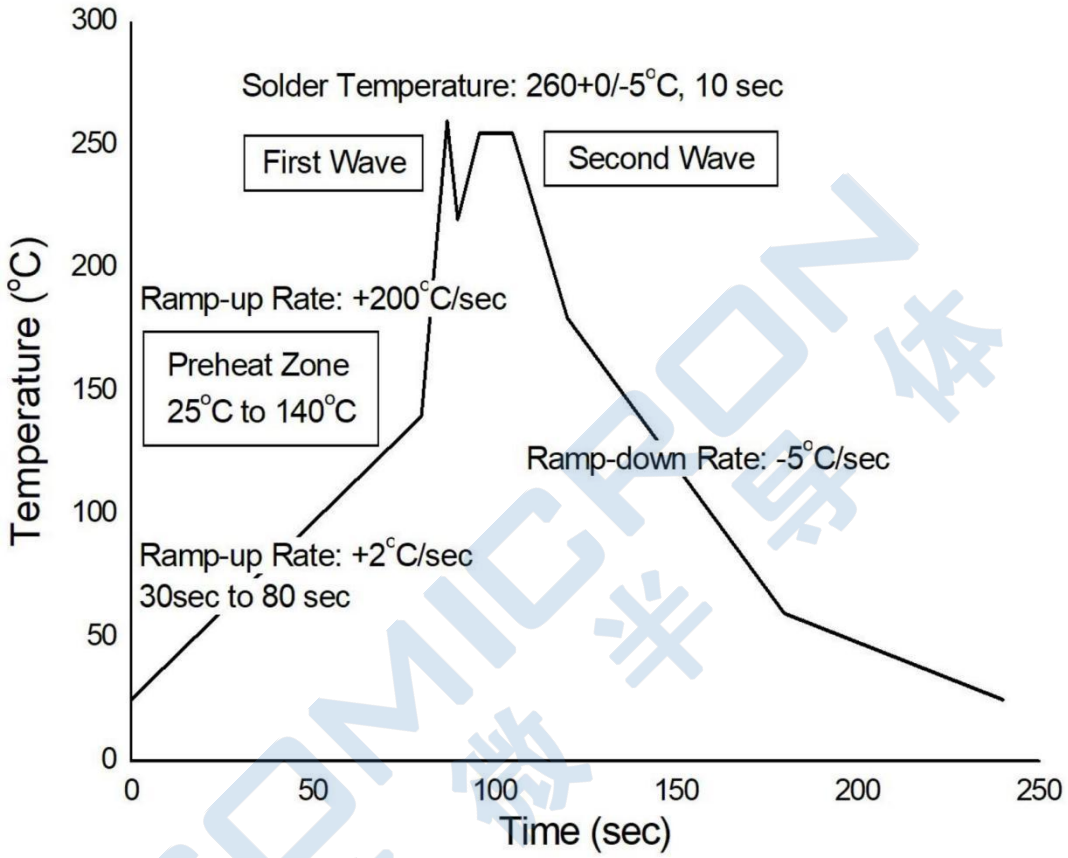
Reflow Profile



Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	100	150°C
Temperature Max. (Tsmax)	150	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds	60-120 seconds
Ramp-up Rate (tL to tP)	3°C/second max.	3°C/second max.
Liquidous Temperature (TL)	183°C	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time (tP) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.

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TEMPERATURE PROFILE OF SOLDERING

Wave Soldering (JESD22-A111 Compliant)


Hand Soldering By Soldering Iron	
Soldering Temperature	380+0/-5°C
Soldering Time	3 sec max.

- **One time soldering is recommended for all soldering method.**
- **Do not solder more than three times for IR reflow soldering.**

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- Please contact ISOMICRON sales agent for special application request.
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- Discoloration might be occurred on the package surface after soldering, reflow or long-time use. It neither impacts the performance nor reliability.

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